

# **Regulating Pulse Width Modulator**

### Description

The SG1525A/1527A series of pulse width modulator integrated circuits are designed to offer improved performance and lower external parts count when used to implement all types of switching power supplies. The on-chip +5.1 V reference is trimmed to  $\pm 1\%$ initial accuracy and the input common-mode range of the error amplifier includes the reference voltage, eliminating external potentiometers and divider resistors. A Sync input to the oscillator allows multiple units to be slaved together, or a single unit to be synchronized to an external system clock. A single resistor between the  $C_T$  pin and the Discharge pin provides a wide range of deadtime adjustment. These devices also feature built-in soft-start circuitry with only a timing capacitor required externally. A Shutdown pin controls both the soft-start circuitry and the output stages, providing instantaneous turn-off with soft-start recycle for slow turn-on. These functions are also controlled by an undervoltage lockout which keeps the outputs off and the soft-start capacitor discharged for input voltages less than that required for normal operation. Another unique feature of these PWM circuits is a latch following the comparator. Once a PWM pulse has been terminated for any reason, the outputs remain off for the duration of the period. The latch is reset with each clock pulse. The output stages are totempole designs capable of sourcing or sinking in excess of 200mA. The SG1525A output stage features NOR logic, giving a LOW output for an OFF state. The SG1527A utilizes OR logic, which results in a HIGH output level when OFF.

#### Features

- 8V to 35V Operation
- 5.1V Reference Trimmed to ±1%
- 100Hz to 500kHz Oscillator Range
- Separate Oscillator Sync Terminal
- Adjustable Deadtime Control
- Internal Soft-start
- Input Undervoltage Lockout
- Latching P.W.M. to Prevent Multiple Pulses
- Dual Source/Sink Output Drivers

## **High Reliability Features**

Following are the high reliability features of SG1525A and SG1527A:

- Available to MIL-STD-883, ¶ 1.2.1
- MIL-M38510/12602BEA JAN1525AJ
- MIL-M38510/12604BEA JAN1527AJ
- MSC-AMS level "S" Processing Available



#### Figure 1 - Block Diagram



# **Connection Diagrams and Ordering Information**

Ambient Temperature	Туре	Package	Part Number	Packaging Type	Connection Diagram
			SG1525AJ-883B		
			SG1525AJ-JAN		
			SG1525AJ-DESC		
-55°C to			SG1525AJ		INV. Input $\Box_1 $ 16 $\Box_{\text{REF}}$ N.I. Input $\Box_2$ 15 $\Box_{\text{VN}}$
125°C			SG1527AJ-883B		
	J	16-PIN	SG1527AJ-JAN		OSC. Output 4 13 V <sub>C</sub>
	5	ceramic DIP	SG1527AJ-DESC	CERDIP	$C_T \Box 5$ 12 Ground
			SG1527AJ		R <sub>T</sub> ☐ 6 11 Output A Discharge ☐ 7 10 Shutdown
0500 1- 0500			SG2525AJ		Soft-start 8 9 Compensation
-25°C to 85°C			SG2527AJ		
000 to 7000			SG3525AJ		N Package: RoHS Compliant / Pb-free
-0°C to 70°C			SG3527AJ		Transition DC: 0503
			SG2525AN		N Package: RoHS / Pb-free 100%
-25°C to 85°C	N	16-PIN	SG2527AN		Matte Tin Lead Finish
000 1- 7000		plastic DIP	SG3525AN	PDIP	
-0°C to 70°C			SG3527AN		
			SG2525ADW		
-25°C to 85°C			SG2527ADW		
			SG3525ADW		SYNC     3     14     □Output B       OSC. Output     4     13     □V <sub>c</sub>
-0°C to 70°C	DW	16-pin wide body plastic SOIC	SG3527ADW	SOIC	Cr   5   12   Ground     Rr   6   11   Output A     Discharge   7   10   Shutdown     Soft-start   8   9   Compensation     DW Package: RoHS Compliant / Pb- free Transition DC: 0516   DW Package: RoHS / Pb-free 100%     DW Package: RoHS / Pb-free 100%   Matte Tin Lead Finish
			SG1525AL-883B		1. N.C. <u>3 2 1 20 19</u> 11. N.C.
		20-pin	SG1525AL		2. INV. Input 3. N.I. Input 4
-55°C to 125°C	L	ceramic leadless	SG1527AL-883B	CLCC	4. SYNC 5 5. OSC. Output 6 6. N.C. 7 7 7 14. Output A 15. Ground 16 16. N.C. 16. N.C. 16. N.C. 17. V <sub>c</sub>
		chip carrier (LCC)	SG1527AL		$ \begin{array}{cccccccccccccccccccccccccccccccccccc$

1. Contact factory for JAN and DESC product availability.

 All packages are viewed from the top.
Hermetic Packages J & L use Sn63Pb37 hot solder dip lead finish, contact factory for availability of RoHS compliant versions.



# Absolute Maximum Ratings<sup>1</sup>

Parameter	Value	Units
Supply Voltage (+V <sub>IN</sub> )	40	V
Collector Supply Voltage (V <sub>C</sub> )	40	V
Logic Inputs	-0.3 to 5.5	V
Analog Inputs	-0.3 to V <sub>IN</sub>	V
Output Current, Source or Sink	500	mA
Reference Load Current	50	mA
Oscillator Charging Current	5	mA
Operating Junction Temperature		
Hermetic (J, L Packages)	150	°C
Plastic (N, DW Packages)	150	°C
Storage Temperature Range	-65 to 150	°C
Lead Temperature (Soldering, 10 seconds)	300	°C
RoHS Peak Package Solder Reflow Temp. (40 s max. exp.)	260 (+0, -5)	°C
Note: Values beyond which damage may occur		

# **Thermal Data**

Parameter	Value	Units
J Package		
Thermal Resistance-Junction to Case, $\theta_{JC}$	30	°C/W
Thermal Resistance-Junction to Ambient, $\theta_{JA}$	80	°C/W
N Package		
Thermal Resistance-Junction to Case, $\theta_{JC}$	40	°C/W
Thermal Resistance-Junction to Ambient, $\theta_{JA}$	65	°C/W
DW Package		
Thermal Resistance-Junction to Case, $\theta_{JC}$	40	°C/W
Thermal Resistance-Junction to Ambient, $\theta_{JA}$	95	°C/W
L Package		
Thermal Resistance-Junction to Case, $\theta_{JC}$	35	°C/W
Thermal Resistance-Junction to Ambient, $\theta_{JA}$	120	°C/W
Notes:		

Notes:

1. Junction Temperature Calculation:  $T_J = T_A + (P_D \times \theta_{JA})$ .

2. The above numbers for  $\theta_{JC}$  are maximums for the limiting thermal resistance of the package in a standard mounting configuration. The  $\theta_{JA}$  numbers are meant to be guidelines for the thermal performance of the device/pc-board system. All of the above assume no ambient airflow.



# Recommended Operating Conditions<sup>1</sup>

Parameter	Value	Units
Input Voltage (+V <sub>IN</sub> )	8 to 35	V
Collector Voltage (V <sub>C</sub> )	4.5 to 35	V
Sink/Source Load Current (steady state)	0 to 100	mA
Sink/Source Load Current (peak)	0 to 400	mA
Reference Load Current	0 to 20	mA
Oscillator Frequency Range	0.1 to 350	kHz
Oscillator Timing Resistor (RT)	2 to 150	kΩ
Deadtime Resistor Range (R <sub>D</sub> )	0 to 500	Ω
Maximum Shutdown Source Impedance	5	kΩ
Oscillator Timing Capacitor (CT)	0.001 to 0.1	μF
Operating Ambient Temperature Range <sup>1</sup>		
SG1525A/SG1527A	-55 to 125	°C
SG2525A/SG2527A	-25 to 85	°C
SG3525A/SG3527A	0 to 70	°C
Note: Range over which the device is functional.	· · ·	

### **Electrical Characteristics**

(Unless otherwise specified, these specifications apply over the operating ambient temperatures for SG1525A/SG1527A with -55°C  $\leq$  T<sub>A</sub>  $\leq$  125°C, SG2525A/SG2527A with -25°C  $\leq$  T<sub>A</sub>  $\leq$  85°C, SG3525A/SG3527A with 0°C  $\leq$  T<sub>A</sub>  $\leq$  70°C, and +V<sub>IN</sub> = 20V. Low duty cycle pulse testing techniques are used that maintains junction and case temperatures equal to the ambient temperature.)

Parameter	Test Conditions	SG1525A/2525A SG1527A/2527A		SG3525A SG3527A			Units	
		Min	Тур	Max	Min	Тур	Max	
Reference Section <sup>1</sup>								
Output Voltage	TJ= 25°C	5.05	5.10	5.15	5.00	5.10	5.20	V
Line Regulation	V <sub>IN</sub> = 8V to 35V		10	30		10	30	mV
Load Regulation	I∟= 0 to 20mA		20	50		20	50	mV
Temperature Stability <sup>1</sup>	Over Operating Temperature Range		20	50		20	50	mV
Total Output Voltage Range <sup>1</sup>	Over Line, Load and Temperature	5.00		5.20	4.95		5.25	V
Short Circuit Current	$V_{REF} = 0V, T_J = 25^{\circ}C$		80	100		80	100	mA
Output Noise Voltage <sup>1</sup>	$10Hz \le f \le 10kHz$ , T <sub>J</sub> = 25°C		40	200		40	200	μVrms
Long Term Stability <sup>1</sup>	T <sub>J</sub> = 125°C		20	50		20	50	mV/khr
Notos	•			•	•	•	• •	

Notes:

1. These parameters, although guaranteed over the recommended operating conditions, are not 100% tested in production.

2.  $F_{OSC} = 40 \ kHz \ (R_T = 3.6k \ \Omega, \ C_T = 0.01 \ \mu F, \ R_D = 0 \ \Omega.).$ 

3. Applies to SG1525A/2525A/3525A only, due to polarity of output pulses.

# Electrical Characteristics (continued)

Parameter	Test Conditions	SG1525A/2525A SG1527A/2527A		SG3525A/SG3527A		Units		
		Min	Тур	Мах	Min	Тур	Max	•
Oscillator Section <sup>2</sup>							II	
Initial Accuracy	$T_J = 25^{\circ}C$	37.6	40	42.4	37.6	40	42.4	kHz
Voltage Stability	$V_{IN} = 8V$ to $35V$		±0.3	±1		±1	±2	%
Temperature Stability <sup>1</sup>	$MIN \leq T_{J} \leq MAX$		±3	±6		±3	±6	%
Minimum Frequency <sup>1</sup>	$R_T = 150 k\Omega, C_T = 0.1 \mu F$			150			150	Hz
Maximum Frequency <sup>1</sup>	$R_T = 2 k\Omega, C_T = 1nF$	350			350			kHz
Current Mirror	I <sub>RT</sub> = 2mA	1.7	2.0	2.2	1.7	2.0	2.2	mA
Clock Amplitude		3.0	3.5		3.0	3.5		V
Clock Width	$T_J = 25^{\circ}C$	0.3	0.5	1.0	0.3	0.5	1.0	μs
Sync Threshold		1.2	2.0	2.8	1.2	2.0	2.8	V
Sync Input Current	Sync Voltage = 3.5V		1.0	2.5		1.0	2.5	mA
Error Amplifier Section (	V <sub>CM</sub> = 5.1V)							
Input Offset Voltage			0.5	5		2	10	mV
Input Bias Current			1	10		1	10	μA
Input Offset Current				1			1	μA
DC Open Loop Gain	R <sub>L</sub> ≥ 10MΩ, T <sub>J</sub> = 25°C	60	75		60	75		dB
Output Low Level			0.2	0.5		0.2	0.5	V
Output High Level		3.8	5.6		3.8	5.6		V
Common Mode Rejection	V <sub>CM</sub> = 1.5V to 5.2 V	60	75		60	75		dB
Supply Voltage Rejection	$V_{IN} = 8V$ to $35V$	50	60		50	60		dB
<b>PWM Comparator Sectior</b>	1 <sup>2</sup>							
Minimum Duty Cycle	$V_{COMP} = 0.6V$			0			0	%
Maximum Duty Cycle	$V_{COMP} = 3.6V$	45	49		45	49		%
Input Threshold <sup>2</sup>	Zero Duty Cycle	0.6	0.9		0.6	0.9		V
	Maximum Duty Cycle		3.3	3.6		3.3	3.6	V
Input Bias Current			0.05	2.0		0.05	2.0	μA
Soft-Start Section								
Soft Start Current	V <sub>SHUTDOWN</sub> = 0V	25	50	80	25	50	80	μA
Soft Start Voltage	V <sub>SHUTDOWN</sub> = 2V		0.4	0.6		0.4	0.6	V
Shutdown Input Current	V <sub>SHUTDOWN</sub> = 2.5V		0.4	1.0		0.4	1.0	mA



Parameter	Test Conditions	SG1525A/2525A SG1527A/2527A		SG3525A/SG3527A		Units		
	Test conditions	Min	Тур	Max	Min	Тур	Max	
<b>Output Drivers Section</b>	(each transistor, $V_c = 20V$ )	1						
Output High Level	I <sub>SOURCE</sub> = 20mA	18	19		18	19		V
	I <sub>SOURCE</sub> = 100mA	17	18		17	18		V
Output Low Level	I <sub>SINK</sub> = 20mA		0.2	0.4		0.2	0.4	V
	$I_{SINK} = 100 \text{mA}$		1.0	2.2		1.0	2.2	V
Undervoltage Lockout	$V_{COMP}$ and $V_{SS}$ = High	6	7	8	6	7	8	V
Collector Leakage <sup>3</sup>	$V_{\rm C} = 35V$			200			200	μA
Rise Time	$C_L = 1nF, T_J = 25^{\circ}C$		100	600		100	600	ns
Fall Time	$C_L = 1nF, T_J = 25^{\circ}C$		50	300		50	300	ns
Shutdown Delay <sup>1</sup>	$V_{SD} = 3V, C_S = 0,$ $T_J = 25^{\circ}C$		0.2	0.5		0.2	0.5	μs
Total Standby Current								
Standby Current	V <sub>IN</sub> = 35V		14	20		14	20	mA
Notes:	•	•	•		•	•	• •	

1. These parameters, although guaranteed over the recommended operating conditions, are not 100% tested in production. 2.  $F_{OSC} = 40 \text{ kHz} (R_T = 3.6 \text{ }\Omega, C_T = 0.01 \mu F, R_D = 0\Omega).$ 3. Applies to SG1525A/2525A/3525A only, due to polarity of output pulses.



## **Oscillator Section**



Figure 2 · Oscillator Schematic



Figure 3 - Oscillator Charge Time versus RT And CT



Figure 4 - Oscillator Discharge Time versus R<sub>D</sub> And C<sub>T</sub>



# **Error Amplifier Section**



Figure 5 - Error Amplifier



Figure 6 · Error Amplifier Open-Loop Frequency Response



Figure 7 - Output Circuit (1/2 circuit shown)



Figure 8 - Output Saturation Characteristics

# **Output Section**



## **Application Information**



For single-ended supplies, the driver outputs are grounded. The  $V_C$  terminal is switched to ground by the totem-pole source transistors on alternate oscillator cycles.



In conventional push-pull bipolar designs, forward base drive is controlled by  $R_1 - R_3$ . Rapid turn-off times for the power devices are achieved with speed-up capacitors  $C_1$  and  $C_2$ .



The low source impedance of the output drivers provides rapid charging of power FET input capacitance while minimizing external components.



Low power transformers can be driven directly by the SG1525A. Automatic reset occurs during deadtime, when both ends of the primary winding are switched to ground.



#### **Shutdown Options**

- 1. Use an external transistor or open-collector comparator to pull down on the Comp terminal. This sets the PWM latch turning off both outputs. If the shutdown signal is momentary, pulse-by-pulse protection can be accomplished as the PWM latch resets with each clock pulse.
- 2. The same results can be accomplished by pulling down on the Soft-Start terminal with the difference that on this pin, shutdown does not affect the amplifier compensation network but must discharge any Soft-Start capacitor.
- 3. Apply a positive-going signal to the Shutdown terminal. This provides most rapid shutdown of the outputs but will not immediately set the PWM latch if there is a Soft-Start capacitor. This capacitor discharges but with a current of approximately twice the charging current.
- 4. The shutdown terminal can be used to set the PWM latch on a pulse-by-pulse basis if there is no external capacitance on Soft-Start terminal. Slow turn-on may still be accomplished by applying an external capacitor, blocking diode, and charging resistor to the comp terminal. (See SG1524 Application Note).



Figure 9 · SG1525A/1527A Lab Test Fixture

## Package Outline Dimensions

Controlling dimensions are in metric, inches equivalents are shown for general information.



Dim	MILLIM	ETERS	INCHES		
Dim	MIN	MAX	MIN	MAX	
А	2.06	2.65	0.081	0.104	
A1	0.10	0.30	0.004	0.012	
A2	2.03	2.55	0.080	0.100	
В	0.33	0.51	0.013	0.020	
С	0.23	0.32	0.009	0.013	
D	10.08	10.50	0.397	0.413	
Е	7.40	7.60	0.291	0.299	
е	1.27 BSC		0.05	BSC	
Н	10.00	10.65	0.394	0.419	
L	0.40	1.27	0.016	0.050	
θ	0°	8°	0°	8°	
*LC	-	0.10	-	0.004	

\*Lead co planarity

#### Note:

Dimensions do not include protrusions; these shall not exceed 0.155mm (.006") on any side. Lead dimension shall not include solder coverage. Dimensions are in mm, inches are for reference only.

Figure 10 - DW 16-Pin SOWB Package Dimensions



Dim	MILLIM	MILLIMETERS		HES
Dim	MIN	MAX	MIN	MAX
Α	-	5.33	-	0.210
A1	0.38	-	0.015	-
A2	3.30	Тур.	0.13	0 Тур.
b	0.36	0.56	0.014	0.022
b1	1.14	1.78	0.045	0.070
С	0.20	0.36	0.008	0.014
D	18.67	19.69	0.735	0.775
е	2.54 BSC		0.10	D BSC
E	7.62	8.26	0.300	0.325
E1	6.10	7.11	0.240	0.280
L	2.92	0.381	0.115	0.150
θ	-	15°	-	15°

#### Note:

Dimensions do not include protrusions; these shall not exceed 0.155mm (.006") on any side. Lead dimension shall not include solder coverage. Dimensions are in mm, inches are for reference only.

Figure 11 · N 16-Pin Plastic Dual Inline Package Dimensions



### Package Outline Dimensions (continued)

Controlling dimensions are in inches, metric equivalents are shown for general information.



Dim	MILLIM	ETERS	INC	HES
Dim	MIN	MAX	MIN	MAX
А	-	5.08	-	0.200
b	0.38	0.51	0.015	0.020
b2	1.04	1.65	0.045	0.065
С	0.20	0.38	0.008	0.015
D	19.30	19.94	0.760	0.785
Ш	5.59	7.11	0.220	0.280
е	2.54	BSC	0.10	0 BSC
eA	7.37	7.87	0.290	0.310
Н	0.63	1.78	0.025	0.070
L	3.18	5.08	0.125	0.200
α	-	15°	-	15°
Q	0.51	1.02	0.020	0.040

#### Note:

Dimensions do not include protrusions; these shall not exceed 0.155mm (.006") on any side. Lead dimension shall not include solder coverage.

Figure 12 - J 16-Pin Ceramic Dual Inline Package Dimensions



Dim	MILLIM	ETERS	INC	HES	
Dim	MIN	MAX	MIN	MAX	
D/E	8.64	9.14	0.340	0.360	
E3	-	8.128	-	0.320	
е	1.270	BSC	0.050	D BSC	
B1	0.635	TYP	0.025 TYP		
L	1.02	1.52	0.040	0.060	
А	1.626	2.286	0.064	0.090	
h	1.016 TYP		0.040	0 TYP	
A1	1.372	1.68	0.054	0.066	
A2	-	1.168	-	0.046	
L2	1.91	2.41	0.075	0.95	
B3	0.20	3R	0.0	08R	

#### Note:

All exposed metalized area shall be gold plated 60 micro-inch minimum thickness over nickel plated unless otherwise specified in purchase order.

Figure 13 - L 20-Pin Ceramic LCC Package Outline Dimensions



Microsemi Corporate Headquarters One Enterprise, Aliso Viejo CA 92656 USA Within the USA: +1 (800) 713-4113 Outside the USA: +1 (949) 380-6100 Sales: +1 (949) 380-6136 Fax: +1 (949) 215-4996 E-mail: sales.support@microsemi.com Microsemi Corporation (Nasdaq: MSCC) offers a comprehensive portfolio of semiconductor and system solutions for communications, defense and security, aerospace, and industrial markets. Products include high-performance and radiation-hardened analog mixed-signal integrated circuits, FPGAs, SoCs, and ASICs; power management products; timing and synchronization devices and precise time solutions, setting the world's standard for time; voice processing devices; RF solutions; discrete components; security technologies and scalable anti-tamper products; Power-over-Ethernet ICs and midspans; as well as custom design capabilities and services. Microsemi is headquartered in Aliso Viejo, Calif. and has approximately 3,400 employees globally. Learn more at **www.microsemi.com**.

© 2014 Microsemi Corporation. All rights reserved. Microsemi and the Microsemi logo are trademarks of Microsemi Corporation. All other trademarks and service marks are the property of their respective owners.